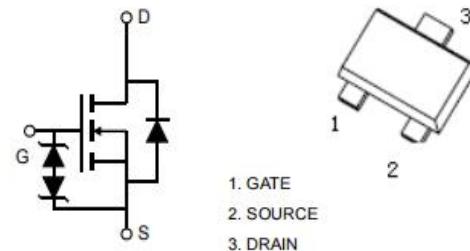


**SOT-723 20V N Channel Enhancement ESD Protection 沟道增强型带静电保护
MOS Field Effect Transistor 场效应管**



■ Absolute Maximum Ratings 最大额定值

Characteristic 特性参数	Symbol 符号	Rating 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	BV_{DSS}	20	V
Gate- Source Voltage 栅极-源极电压	V_{GS}	± 10	V
Drain Current (continuous)漏极电流-连续	I_D (at $T_A = 25^\circ C$)	0.75	A
Drain Current (pulsed)漏极电流-脉冲	I_{DM}	1.8	A
Total Device Dissipation 总耗散功率	P_D (at $T_A = 25^\circ C$)	150	mW
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}$	887	°C/W
ESD Protected Up to 人体模式静电保护范围	ESD(HBM)	2.0	kV
Junction/Storage Temperature 结温/储存温度	T_J, T_{stg}	-55~150	°C

■ Device Marking 产品字标

FS3134KT=2*

■ Electrical Characteristics 电特性(T_A=25°C unless otherwise noted 如无特殊说明, 温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D =250μA, V _{GS} =0V)	BV _{DSS}	20	—	—	V
Gate Threshold Voltage 栅极开启电压(I _D =250μA, V _{GS} = V _{DS})	V _{GS(th)}	0.35	0.7	1	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} = 20V)	I _{DSS}	—	—	1	μA
Gate Body Leakage 栅极漏电流(V _{GS} =±10V, V _{DS} =0V)	I _{GSS}	—	—	±20	μA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D =0.5A, V _{GS} =4.5V) (I _D =0.5A, V _{GS} =2.5V) (I _D =0.45A, V _{GS} =1.8V)	R _{DSS(ON)}	—	270 320 390	400 500 800	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I _{SD} =0.15A, V _{GS} =0V)	V _{SD}	—	—	1.2	V
Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} =16V, f=1MHz)	C _{ISS}	—	79	—	pF
Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} =16V, f=1MHz)	C _{OSS}	—	13	—	pF
Reverse Transfer Capacitance 反馈电容(V _{GS} =0V, V _{DS} =16V, f=1MHz)	C _{RSS}	—	9	—	pF
Total Gate Charge 棚极电荷密度 (V _{DS} =10V, I _D =0.25A, V _{GS} =4.5V)	Q _g	—	0.75	—	nC
Gate Source Charge 棚源电荷密度 (V _{DS} =10V, I _D =0.25A, V _{GS} =4.5V)	Q _{gs}	—	0.075	—	nC
Gate Drain Charge 棚漏电荷密度 (V _{DS} =10V, I _D =0.25A, V _{GS} =4.5V)	Q _{gd}	—	0.225	—	nC
Turn-ON Delay Time 开启延迟时间 (V _{DS} =10V I _D =0.5A, R _{GEN} =10 Ω, V _{GS} =4.5V)	t _{d(on)}	—	6.7	—	ns
Turn-ON Rise Time 开启上升时间 (V _{DS} =10V I _D =0.5A, R _{GEN} =10 Ω, V _{GS} =4.5V)	t _r	—	4.8	—	ns
Turn-OFF Delay Time 关断延迟时间 (V _{DS} =10V I _D =0.5A, R _{GEN} =10 Ω, V _{GS} =4.5V)	t _{d(off)}	—	17.3	—	ns
Turn-OFF Fall Time 关断下降时间 (V _{DS} =10V I _D =0.5A, R _{GEN} =10 Ω, V _{GS} =4.5V)	t _f	—	7.4	—	ns

■Typical Characteristic Curve 典型特性曲线

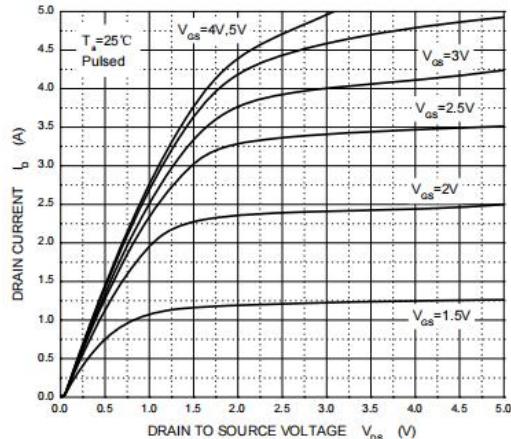


Figure 1: Output Characteristics

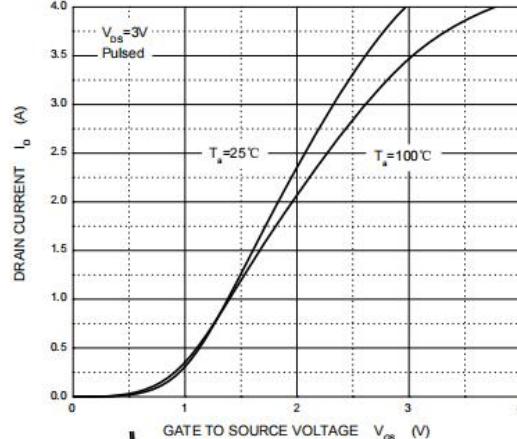


Figure 2: Transfer Characteristics

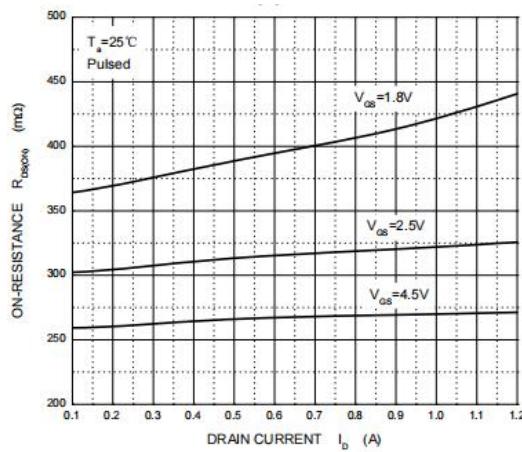


Figure 3: On-Resistance vs. Drain Current

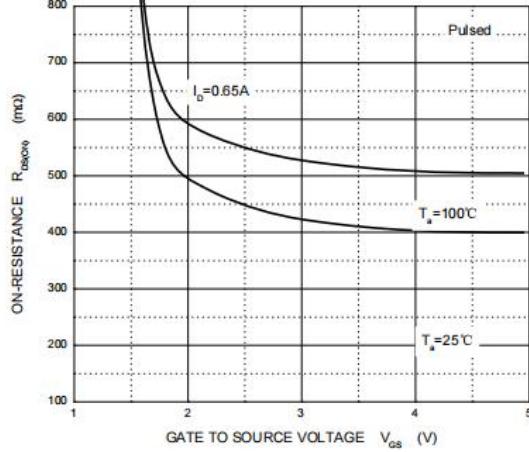


Figure 4: On-Resistance vs. V_{GS}

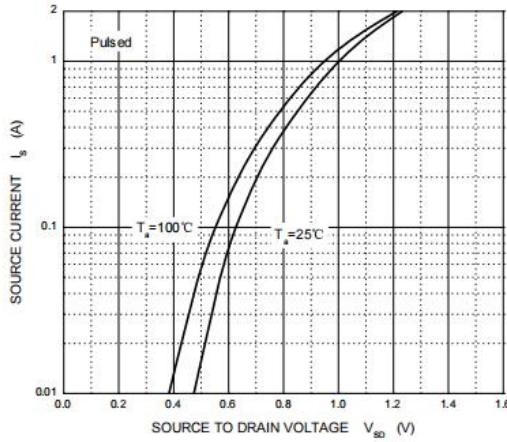


Figure 5: Diodee Characteristics

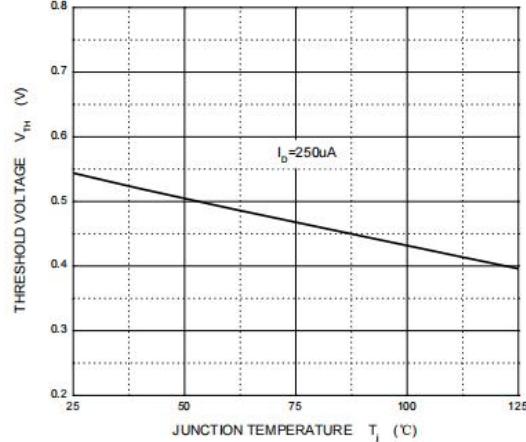
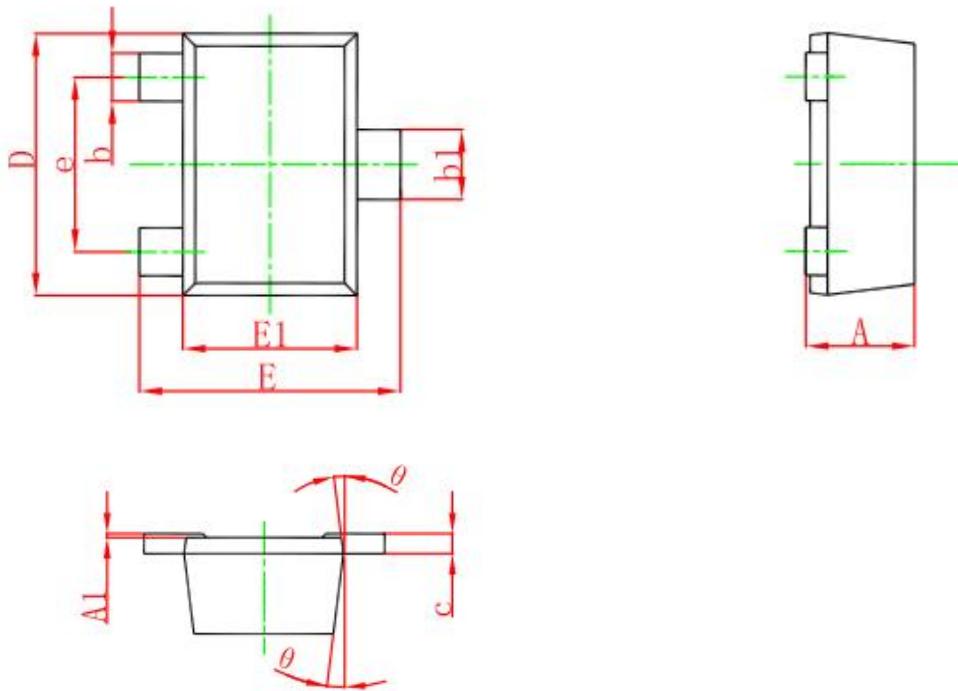


Figure 6: Threshold Characteristics

■ Dimension 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.430	0.500	0.017	0.020
A1	0.000	0.050	0.000	0.002
b	0.170	0.270	0.007	0.011
b1	0.270	0.370	0.011	0.015
c	0.080	0.150	0.003	0.006
D	1.150	1.250	0.045	0.049
E	1.150	1.250	0.045	0.049
E1	0.750	0.850	0.030	0.033
e	0.800TYP.		0.031TYP.	
θ	7° REF.		7° REF.	